Document Number: MHPA18010N

Rev. 4, 5/2006

CDMA Band RF Linear LDMOS Amplifier

Designed for Class AB amplifier applications in 50 ohm systems operating in the 1800 to 1900 MHz frequency band. A silicon FET design provides outstanding linearity and gain. In addition, the excellent group delay and phase linearity characteristics are ideal for digital CDMA and GSM modulation

- Typical CDMA Performance: 1840 MHz, 28 Volts IS-95 CDMA Pilot, Sync, Paging, Traffic Codes 8 Through 13
- Adjacent Channel Power: -51 dBc @ 30 dBm Average Power, 885 kHz Channel Spacing
- Power Gain: 24.5 dB Min (@ f = 1840 MHz)

- Excellent Phase Linearity and Group Delay Characteristics
- Ideal for Feedforward Base Station Applications
- N Suffix Indicates Lead-Free Terminations

MHPA18010N

1805-1880 MHz 10 W. 24.5 dB **RF HIGH POWER LDMOS AMPLIFIER**

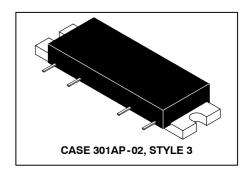


Table 1. Maximum Ratings (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
DC Supply Voltage	V_{DD}	30	Vdc
RF Input Power (Single Carrier CW)	P _{in}	+20	dBm
Storage Temperature Range	T _{stg}	- 40 to +100	°C
Operating Case Temperature Range	T _C	- 20 to +100	°C

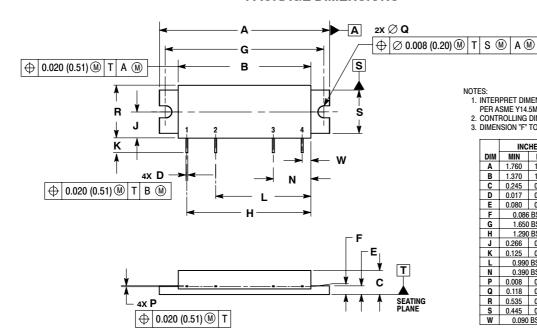
Table 2. Electrical Characteristics (V_{DD} = 28 Vdc, $V_{BIAS} \cong 8$ V Set for Supply Current of 600 mA, T_C = 25°C, 50 Ω System)

Characteri	Symbol	Min	Тур	Max	Unit	
Supply Current		I _{DD}	_	600	_	mA
Power Gain	(f = 1840 MHz)	G _p	24.5	25.5	_	dB
Gain Flatness	(f = 1805 - 1880 MHz)	G _F	_	0.2	0.5	dB
Power Output @ 1 dB Comp.	(f = 1840 MHz)	P1dB	_	41.5	_	dBm
Input VSWR	(f = 1805 - 1880 MHz)	VSWR _{in}	_	1.5:1	2:1	
Noise Figure	(f = 1840 MHz)	NF	_	8	10	dB
Adjacent Channel Power Rejection @ 30 dBm Average Power, 1.23 MHz BW, 885 kHz Channel Spacing		ACPR	_	-58	- 51	dBc



NOTES

PACKAGE DIMENSIONS



- NOTES:
 1. INTERPRET DIMENSIONS AND TOLERANCES
 PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION "F" TO CENTER OF LEADS.

	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	1.760	1.780	44.70	45.21		
В	1.370	1.390	34.80	35.31		
С	0.245	0.265	6.22	6.73		
D	0.017	0.023	0.43	0.58		
Е	0.080	0.100	2.03	2.54		
F	0.086	BSC	2.18 BSC			
G	1.650	BSC	41.91 BSC			
Н	1.290	BSC	32.77	7 BSC		
J	0.266	0.280	6.76	7.11		
K	0.125	0.165	3.18	4.19		
L	0.990 BSC		25.15 BSC			
N	0.390 BSC		9.91 BSC			
P	0.008	0.013	0.20	0.33		
Q	0.118	0.132	3.00	3.35		
R	0.535	0.555	13.59	14.10		
S	0.445	0.465	11.30	11.81		
W	0.090 BSC		2.29 BSC			

STYLE 3:
PIN 1. RF INPUT
2. VBIAS
3. VDD
4. RF OUTPUT
CASE: GROUND

CASE 301AP-02 ISSUE E

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